3.3 Supported Series C I/O modules

The list of I/O modules below can be used on a Series C IOLINK. The IOLINK contains a function that enables programming and reprogramming the executable image (rather than substitution of a removable hardware component). The preferred method of delivery of the image is over the IOLINK.

Tip

Series C IOLINK cannot contain any PM I/O IOPs.

C300 IOLINK block parameter IOLINKTYPE is used to determine if the IOLINK supports either Series C I/O or PM I/O.

Table 5: Available I/O modules

Following Series C IO modules introduced in Experion PKS R410.

These modules must be used only with Experion PKS R410 and later. These modules will not work as expected with earlier releases of Experion PKS. Using these with Experion releases prior to R410 by downgrading the firmware may render the module faulty and may not be possible to recover.

NOTES:

- 1. There are two models of High Level Analog Input such as, CU-PAIX01 and CU-PAIN01. The Module Hardware and the corresponding IOTAs are different and CU-PAIN01 is a new model. From the perspective of configuration and implementation, both High Level Analog Input models use the same IOM Block such as, AI-HL. It must be noted that the two models utilize the same configuration; online migration is not possible as mixed redundant pair is not possible. There are two models of Analog Output such as, CU-PAOX01 and CU-PAON01. Hence, similarly configuration, implementation, and interoperability constraints apply and CU-PAON01 is the new model.
- 2. Two new models of AI-HART (CC-PAIH02) and AI-HL (CC-PAIX02) modules are introduced to replace the older models of the AI-HART (CC-PAIH01) and AI-HL (CC-PAIX01) modules. The new models support both single-ended and differential inputs.
- 3. With R410, a new model of HART Analog Input CC-PAIH51 is introduced. The HART Analog Input CC-PAIH51 and Cx-PAIH01 use the same IOM block, that is, AI-HART. The configuration and implementation mentioned in note 1 applies to the HART Analog Input module.
- 4. With R410, a new model of HART Analog Output CC-PAOH51 is introduced. The HART Analog Output CC-PAOH51 and Cx-PAOH01 use the same IOM block, that is., AO-HART. The configuration and implementation mentioned in note 1 applies to the HART Analog Output module.
- 5. With R410, a new model of Digital Input 24V DC CC-PDIL51 is introduced. The Digital Input 24V DC CC-PDIL51 and Cx-PDIL01 use the same IOM block, that is, DI-24. The configuration and implementation mentioned in note 1 applies to the Digital Input 24V module.
- 6. With R410, a new model of Digital Output 24V DC CC-PDOD51 is introduced. The Digital Output 24V DC CC-PDOD51 and Cx-PDOB01 use the same IOM block, that is, DO-24B. . The configuration and implementation mentioned in note 1 applies to the Digital Output 24V module.
- 7. Starting with R430, a new model of Low Level Analog Input Mux CC-PAIM51 is introduced.
- 8. The UIO (CC-PUIO01) has 32 configurable input or output channels. Each channel can be configured as one of the following:
	- Analog Input (0-20mA or 4-20mA active)
	- Analog Output (4-20mA active)
	- Digital Input (with or without line monitoring)
	- Digital Output (with or without line monitoring)

3.3.1 Compatibility matrix between AI modules and differential AI modules

You can choose the AI modules based on your functionality requirements. The following table lists the functionalities and the respective AI modules.

The following table lists the compatibility matrix between AI modules and differential AI modules for redundant and non-redundant configuration.

Attention

The following module types are superseded by a new version of the module.

- CC-PAIH01 superseded by CC-PAIH02
- CC-PAIX01 superseded by CC-PAIX02
- CC-PAOX01 superseded by CC-PAON01

3.3.2 Compatibility matrix between AO modules and differential AO modules

The following table lists the compatibility matrix between AO modules and differential AO modules for redundant and non-redundant configuration.

3.3.3 Difference between AI-HART modules Cx-PAIH01 and Cx-PAIH51

3.3.4 Difference between AO-HART modules Cx-PAOH01 and Cx-PAOH51

3.3.5 Difference between bussed low voltage Digital Input modules Cx-PDIL01 and Cx-PDIL51

3.3.6 Difference between low voltage Digital Output modules Cx-PDOB01 and Cx-PDOD51

3.3.7 Difference between AI-LLMUX and AI-LLAI modules Cx-PAIM01 and Cx-PAIM51

3.3.8 Identifying supported Series C I/O modules

The Series C I/O model designations follow a 'XX-YZZZNN' format.

Where:

- XX is CC or DC
- CC is for the Series C Product Line.

The model number for every Series C product begins with a C designation for Series C.

- •
- X is U or C

 $(U = Standard Assembly and C = Corrosion protected Assembly)$

- Y is either C, E, F, G, H, K, M, P, PW, S or T
	- $-C =$ Control Processor
	- E = Enclosure
	- $F = FTE$
	- $-G = GI/IS$ Termination Assembly
	- $-$ H = Hazardous Interface
	- $K =$ Cabling
	- M = Mechanical
	- $-$ P = I/O Module
	- $-$ PW = Power
	- $S =$ Custom Interface
	- T = Termination Assembly
- ZZZ is a particular function or model.
- NN is a series of model and can be used as additional model information -

 $NN + 10 =$ Redundant complement to an IOTA.

3.3.9 Considerations for replacing or pairing Series C Analog I/O modules in a redundant configuration

In a redundant series C analog I/O module configuration, consider and complete the following before you replace or pair the modules.

Model number references for the affected Series C Analog I/O modules

3.4 Supported Series C I/O options

The following Series C I/O options are supported:

- I/O redundancy
- Power supply redundancy
- HART communications
- Galvanically Isolated/Intrinsically Safe IOTAs
- Remote I/O (using Fiber Optic I/O Extender)
- Corrosion Protection
- Harsh environment

3.4.1 Inspecting the I/O library

Series C module function blocks and I/O channel blocks are housed in the Series C I/O library of Control Builder.

Figure 6: Series C I/O library

3.4.2 Inspecting IOM function blocks

All IOM function blocks are associated with (children of) an IOLINK function block.

The Series C I/O IOM function blocks are the following:

• AI-HART

- AI-HL
- AI-LLMUX
- AI-LLAI
- AO
- AO-HART
- DI-24
- DI-HV
- DISOE
- DO-24B
- SP
- SVP
- PI
- UIO

3.4.3 Inspecting channel function blocks

The Series C I/O Channel function blocks are the following:

Table 6: Series C I/O channel function blocks

3.4.4 Defining module containment

An individual channel within a Series C I/O block is often abbreviated as an IOC block. While an IOC block must be 'contained in' a Control Module (CM) in Control Builder, the IOC block actually resides within the associated IOM device. This means you change the execution state (EXECSTATE) of a CM independent of the IOC's point execution state (PTEXECST).

Figure 7: Execution State

Figure 8: Point Execution State

3.4.5 Temperature Derating for UIO

The maximum outside module temperature must be limited depending on the internal dissipation.

Attention 0

- Airflow through the module is assumed to be natural convection.
- Ensure that the UIO modules are installed in the correct position. A UIO module must be mounted in the upright position.

To determine the maximum acceptable outside module temperature for a typical configuration, perform the following steps.

1. Perform the **Internal Dissipation Calculation for UIO**.

- a. Determine and record the actual configuration data.
- b. Calculate the totals per dissipation contributor.
- c. Add the totals of the previous step to determine the internal dissipation.
- 2. Using the **Temperature Derating Curves for UIO**, determine the maximum acceptable outside module temperature.

3.4.6 Internal dissipation calculation for UIO

To calculate the maximum outside module temperature, you require the IO configuration. The maximum dissipation caused by the kernel logic of the UIO module is a fixed value. The other dissipation contributions depend on the channel configuration.

Dissipation contributor	Max. dissipation per channel (W)	Number of configured channels	Dissipation (W)
Kernel logic			5.5
DI w/ OWD; field impedance \geq 5 k Ω	0.01		
DI; closed contact; 3.5mA	0.085		
AI; $I < 24mA$; Current limited by field	0.05		
AI; $I > 24mA$; Current limited by UIO $*$	0.49		
DO; $I < 0.3A$	0.115		
DO: $I < 0.5A$	0.305		
AO; 500 Ω field impedance; I < 23mA	0.225		
AO; 250 Ω field impedance; I < 23 mA	0.335		
AO; field impedance < 250 Ω ; I < 23 mA	0.47		
AO; field impedance < 250 Ω ; I < 20 mA	0.42		
Total Power Dissipation (W)			
Max. outside module temperature ${}^{\circ}C$			

Table 7: Dissipation Calculation

* Analog input current above 24mA must be avoided. Field devices for the analog input must be configured to drive current below 24mA. For example, 3.5mA, for sensor fault conditions to minimize the UIO internal power dissipation. The thin-line derating curve needs to be taken when you are using current above 24mA.

3.4.7 Temperature Derating curves for UIO

The following graph displays the maximum outside module temperature versus the internal power dissipation.

Thick line: applicable for most applications having AO<=20mA and AI<=24mA Thin line: applicable if one or more channels have AO>20mA or AI>24mA

3.4.8 Maximum Temperature Alarm for UIO-2

The alarm threshold safe operating temperature is determined based on the I/O channel configuration of the module and the anticipated module inlet air temperature.

Attention

- Airflow through the module is assumed to be natural convection.
- Ensure that the UIO modules are installed in the correct position. A UIO module must be mounted in the upright position.

To determine the maximum acceptable outside module temperature for a typical configuration, perform the following steps:

- 1. Perform the **High Temperature Limit Calculation for UIO-2**.
	- a. Determine and record the actual configuration data and the **Estimated Ambient** inlet air temperature.
	- b. Calculate the totals per dissipation contributor. For each channel type, multiply the total number of configured channels by the corresponding **Maximum Temperature Rise per channel** value.
	- c. Add the totals of the previous step to the **Estimated Ambient** temperature to determine the **High Temperature Limit Setting**. This limit value should not exceed 120 °C.
- 2. Enter the limit value into UIO-2 module configuration screen in Experion Control Builder.

3.4.9 High Temperature Limit Calculation for UIO-2

Table 8: Dissipation Calculation

3.5 I/O Link performance specifications

The concept of a Link Unit (LU) was introduced with PM I/O where a LU was defined as being roughly equivalent to one parameter read (or write) per second.

With the introduction of Series C I/O, the transmission rate of data on an IOLINK configured with Series C I/O is now double that of PM I/O.

Attention

The Specification and Technical information is subject to change without notice and is superseded by information in applicable Experion product Specification and Technical data documents. Hence, for each Experion release, you are recommended to refer the applicable Specification and Technical data documents.

Table 9: Transmission rate of data on an I/O Link

Note: Refer to *Turbine Control User's Guide* for I/O link performance specification of the SPM and SVPM.

3.5.1 Reviewing Link Unit utilization

The Link Unit utilization cycle rate varies depending on the type of block being used. The following table defines the specifications for the various blocks.

3.5.2 Reducing I/O Link traffic

If I/O Link overruns persist, you reduce the I/O Link traffic by:

• Increasing the value of the IOM's Scanning Rate parameter [SCANRATE]

(i.e. increasing the time interval between IOM scans)

- Increase the Execution Period of Control Modules containing Output Channel blocks
- Reducing the number of IOMs configured
- Split the IOMs across multiple IOLINKS
- Check for presence of an address 'Chattering ' alarm events

Tip

Link IDs are only detected on their corresponding modules.

- Modules with Link ID 1 cannot detect Link ID 2.
- Modules with Link ID 2 cannot detect Link ID 1.

3.5.3 Event collection

Under normal conditions, every IOM configured on the I/O Link, whether primary or secondary, uses Link Units for event collection. This activity is periodic and can be accounted for, however; conditions in which numerous events and alarms are generated are unpredictable and may cause transient I/O Link overruns and delays in display updates. These transient overruns clear once the rush of events and alarms are collected.

3.5.4 PV and Back calculation scanning

The following I/O parameters are automatically scanned by the C300 as soon as the IOM block is loaded.

The number of AI and DI channel blocks contained within CMs or SCMs:

• does not increase LU consumption.

The DO channel blocks contained in CMs and SCMs:

• does also not increase LU consumption for Back Calculation scanning, but LU consumption increases for each OP or SO store.

4 Series C I/O Installation and Upgrades

The Experion release utilizes new hardware designs including those for the controllers, I/O modules, and switches. The information contained in this section defines how to establish the various hardware connections and Series C I/O firmware.

To review planning the entire Series C Control System, refer to the Control Hardware Planning Guide's Planning Your Series C Control System.

Related topics

"Installation Declarations" on page 60

"Installing the Series C IOTA on the carrier" on page 63

"Mounting the I/O module on the IOTA" on page 65

"Grounding and power considerations - IOTA boards" on page 66

"Connecting IOMs and field devices through I/O Termination Assemblies" on page 68

"Powering the Series C system" on page 72

"Fusing - Series C IOTA boards" on page 73

4.1 Installation Declarations

Attention

This equipment shall be installed in accordance with the requirements of the National Electrical Code (NEC), ANSI/ NFPA 70, or the Canadian Electrical Code (CEC), C22.1. It is supplied as 'open equipment' that is intended to be mounted on a sub-panel within an enclosure. The suitability of the enclosure and installed system shall be acceptable to the local 'authority having jurisdiction,' as defined in the NEC, or 'authorized person' as defined in the CEC.

Electrostatic discharge

Electrostatic discharge can damage integrated circuits or semiconductors if you touch connector pins or tracks on a printed wiring board.

- Touch a grounded object to discharge static potential
- Wear an approved wrist-strap grounding device
- Do not touch the wire connector or connector pins
- Do not touch circuit components
- If available, use a static safe workstation
- When not in use, keep the component in its static shield box or bag

WARNING ′!`

Unless the location is known to be non-hazardous, do not:

- Connect or disconnect cables
- Install or remove components
- Install or remove isolators

While the control system is powered.

4.1.1 Introduction

The following figure represents the main cabling of the Series C300 controller, Control Firewall, and I/O IOTA boards.

Figure 9: Series C board connections

4.1.2 I/O Link Address Jumpers

The I/O Link Address is configured using a push-on color-coded jumper with a printed number (1-40) that must be installed on each IOTA.

Attention

- IO modules configured using Gray address jumpers must be connected to I/O Link 1 on the C300.
- IO modules configured using Violet address jumpers must be connected to I/O Link 2 on the C300.
- IO modules connected to the wrong I/O Link do not communicate each other.
- The IOM Number parameter (IOMNUM) specifies the address of the module on the I/O Link and must match the I/O Link address jumper on the IOTA
- Only the Honeywell provided address jumper tiles must be used. When changing address jumpers, you must ensure that:
	- (1) The IOM is disconnected from the Link,
	- (2) Power cycled after the address change, then
	- (3) The IOM may be re-connected it back to the Link

4.1.3 Cabling

The following graphic is an example of possible configuration connections with regards to the Series C I/O cabinet. Your configuration may vary based on the module layout of your cabinet. The following table defines cable type and usage in the graphic below.

Figure 10: Series C cabling

4.2 Installing the Series C IOTA on the carrier

- You can use a redundant IOTA to support a non-redundant Series C IOM application. Just be sure to install the non-redundant Series C IOM in the primary location on the IOTA.
- Be sure the enclosure is connected to a protective earth ground using #8 AWG solid copper wire. There should be metal to metal contact between the grounding bus bar and the enclosure as well as the carrier.

Prerequisites

Carrier for mounting IOTA is installed in a cabinet or desired mounting location.

- Power supply is installed.
- Control firewall is installed.
- All wiring and pre-fabricated cables are available and labeled as applicable.
- Be sure all power is turned off at the installation location.
- You have the mounting hardware supplied with the components.

Mounting the IOTA

• Select desired mounting location on carrier and align mounting holes in IOTA with screw-hole locations on the carrier. Be sure component side of IOTA is facing up.

6 inch IOTA board 4 mounting screws

9 inch IOTA board 6 mounting screws 12 inch IOTA board

Attention

When mounting the either the 9 or 12 inch IOTA board, it is recommended to secure the three mounting screws on one side (either left or right) and then secure the other side.

Securing the four corner screws and the two middle screws may cause bowing of the board and impact the alignment of the IOTA board to the carrier holes and is not recommended.

CAUTION

The IOTA power and ground screws can bind during installation or removal if the mounting screws are fully secured before the power/ground screws are installed.

Recommended sequence:

- 1. Secure the IOTA to the carrier tightening the IOTA's mounting screws only half-way. Insert the spacers and washers between bottom of IOTA and top of carrier.
- 2. Install the 24V (power) and ground (common) **screws fully into the bus bars**, torquing the screws to 5 inch pounds.
- 3. Finish installing the IOTA by **tightening the IOTA's mounting screws only full-way**, torquing the screws to 3-inch pounds

4.3 Mounting the I/O module on the IOTA

Prerequisites

It is recommended to attach the IOTA board to the Backplane prior to mounting the module to the IOTA. Ensure the following:

- IOTA is mounted on the Backplane.
- Power supply is installed.
- Control firewall is installed.
- All wiring and pre-fabricated cables are available and labeled as applicable.
- All power is turned off at the installation location.
- You have the mounting hardware supplied with the components.

Mounting the module

- **1** Insert the module onto the IOTA board making sure that the circuit board mates properly with the IOTA board connector.
- **2** Secure the module to the:
	- IOTA board with two screws located on each side of the plastic cover.
	- Backplane with the long gray plastic screw located on the module's face.

Use only a #2 Phillips screw-driver to carefully loosen or tighten the long gray plastic screw. Do not use either a #1 Phillips screw-driver or a battery-powered screw-driver to remove or install the plastic screw as this can damage the screw head.

4.4 Grounding and power considerations - IOTA boards

The Series C cabinet allows mounted carriers that support the attachment of the IOTA boards. By making these connections, power, and chassis, grounding is provided to the IOTA board.

4.4.1 Testing for power

CAUTION

Extreme care must be taken when testing for power at the Series C bus bars. Improper testing can result in an electrical short circuit, which will impact all modules attached to the channel carrier assembly.

Never use a test probe at an unattached IOTA's 24V screw hole. The probe can potentially touch the back channel assembly causing a short circuit.

The following locations are recommended for testing power:

Preferred location if IOTAs are attached

Center of the screw that attaches the IOTA to the 24V bus bar.

Preferred location if IOTAs are NOT attached.

• Center of the screw of top connection terminal for power cable.

Testing for power at IOTA screw

- **1** Insert the test probe at the center of the screw that attaches the IOTA to the 24V power connection.
- **2** This concludes this procedure.

Testing for power at 24V bus bar top terminal

- **1** Carefully pull the red cap from the top of the terminal. It remains attached to the power cable.
	- Insert the test probe at the center of the screw to the 24V power terminal.
- **2** Carefully pull the black cap from the top of the terminal. It remains attached to the ground cable. Insert the test probe at the center of the screw to the COM ground terminal.
- **3** Replace the both caps.
- **4** This concludes this procedure.

Figure 11: Grounding and power connections

4.5 Connecting IOMs and field devices through I/O Termination Assemblies

All connections between IOMs and field devices are through I/O Termination Assemblies (IOTAs). IOTAs are sometimes connected to ancillary hardware that pre-conditions the signal for use in Experion.

The following table defines the relationship between IOM type and the ancillary hardware.

Table 13: IOM types and ancillary hardware

These FTA's pre-condition and package the signals before they are received by the IOTA.

To simplify system hardware selection and to minimize spare parts requirements, IOMs can be used with various types of IOTAs. The following table provides a list of IOMs, their associated IOTAs, and ancillary hardware. All IOM models listed within the same cell can be installed on any of the IOTAs listed in the adjacent cell.

Attention

Connecting Series C IOM's into a Galvanically Isolated / Intrinsically Safe (GI/IS) environment requires specific GI/IS IOTAs.

Refer to the following for GI/IS IOTAs and the IOMs they support: "GI/IS IOTA models" on page 582

Table 14: IOMs, IOTAs, and ancillary cards

NOTES

- 1. Cx-TAIM01 This does NOT require the MU-TLPA02 Power Adapter and supports in-cabinet configuration or in a suitable enclosure up to 1,000 feet remote from the LLMUX IOTA as displayed in Figure 15.
- 2. Cx-TAIM21 requires the MU-TLPA02 Power Adapter and can be mounted in-cabinet and remotely.
- 3. One CC-KREBxx uncoated cable is used to connect the IOTA to the relay extension board.
- 4. One CC-KREBxx coated cable is used to connect the IOTA to the relay extension board.
- 5. Bussed IOM (PDOB01) is used for both bussed outputs and relay outputs, however, only relay outputs require the additional card.
- 6. Redundantly configured IOMs must be installed on a redundant IOTA.
- 7. Non-redundant IOMs can be installed on non-redundant and redundant IOTAs. However, when installed on a redundant IOTA, non-redundant IOMs must be installed in the upper IOM slot of the redundant IOTA.
- 8. The IOTA type used for Series C IO DI-24V is used with the DI-SOE IOM also.
- 9. Non-redundant differential IOTA (CC-TAID01) length is 9', non-redundant IOTA (CC-TAIX01 and CC-TAIN01) length is 6', and differential redundant IOTAs (CC-TAID11, CC-TAIN11, and CC-TAIX11) length is 12'.
- 10. A third level of connector is available for all differential mode connections as an extension of channel 13 through 16 terminals for all 16 channels.
- 11. Differential configuration does not require any custom wiring as the IOTAs (CC-TAID01 and CC-TAID11) performs it internally.
- 12. Two new models of AI-HART (CC-PAIH02) and AI-HL (CC-PAIX02) modules are introduced to replace the older models of the AI-HART (CC-PAIH01) and AI-HL (CC-PAIX01) modules. The new models support both single-ended and differential inputs.
- 13. With R410, new models of AI-HART (Cx-PAIH51), AO-HART (Cx-PAOH51), DI-24V (Cx-PDIL51), and DO-24B2 (Cx-PDOD51) are introduced.